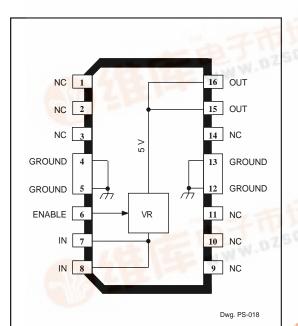
5 V REGULATUR 8181

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LOW-DROPOUT, 5 V REGULATOR — HIGH EFFICIENCY



ABSOLUTE MAXIMUM RA	TINGS
at $T_A = +25^{\circ}C$	
Input Voltage, V _I	10 V
Output Current, Io	
(40% duty cycle)	
(75% duty cycle)	500 mA*
(continuous)	370 mA*
Operating Temperature Range,	
T _A 20°C	to +85°C
Junction Temperature, T.	+150°C†
Storage Temperature Range,	
T _S 40°C t	o +150°C

* Output current rating is limited by input voltage, duty cycle, and ambient temperature. Under any set of conditions, do not exceed a junction temperature of +150°C. See next page.

† Fault conditions that produce excessive junction temperature will activate device thermal shutdown circuitry. These conditions can be tolerated but should be avoided.

.dzsc.com

Especially suited for hand-held, portable, battery-operated equipment such as cellular telephones, the A8181SLB low dropout voltage regulator provides high efficiency for maximum battery life in a minimum package size. Equally applicable to camcorders and portable computers, the device provides a fixed 5 V regulated continuous output at almost 200 mA of load current under worst-case conditions. Under normal operating conditions, output currents over 500 mA are permitted.

A MOSFET pass element delivers high output current with an input-output differential of less than 300 mV. For high efficiency, the low dropout voltage allows a longer battery discharge before output voltage regulation is lost. A low quiescent current, even during high load conditions, makes the device ideal for standby power systems. High regulator accuracy and excellent temperature characteristics are provided by a bandgap reference. An enable input gives the designer complete control over sequential power-up or emergency shutdown.

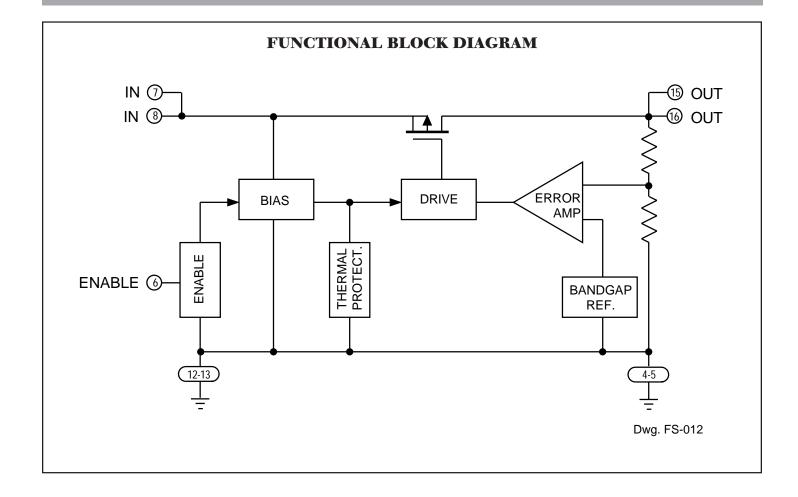
This device is supplied in a 16-lead wide-body, small-outline plastic power package (SOIC) for surface-mount applications. The copper batwing provides for maximum package power dissipation in the smallest possible construction. The A8181SLB is rated for operation over a temperature range of -20° C to $+85^{\circ}$ C.

FEATURES AND BENEFITS

- High Efficiency Provides Extended Battery Life
- Less Than 300 mV Dropout Voltage
- Low Quiescent Current
- >200 mA Output Current
- LSTTL-Compatible ON/OFF Control For Sequential Power-up or Emergency Shutdown
- Internal Thermal Protection
- SOIC Surface-Mount Package

Always order by complete part number: **A8181SLB**





MAXIMUM ALLOWABLE OUTPUT CURRENT with device mounted on 2.24" x 2.24" (56.9 mm x 56.9 mm) solder-coated copper-clad board in still air.

	Maximum Allowable Output Current in Milliamperes with $V_I = 10 \text{ V}$, $T_J = 150^{\circ}\text{C}^*$								
	dc (Duty Cycle)								
T _A	100%	90%	80%	70%	60%	50%	40%	30%	20%
25°C	370	415	465	530	620	745	930	1000	1000
50°C	295	330	370	425	495	595	745	995	1000
70°C	235	265	295	340	395	475	595	795	1000
85°C	190	215	240	275	320	385	485	645	970

* $I_O = (T_J - T_A)/([V_I - V_O] R_{\theta JA} \bullet dc) = (150 - T_A)/(5 \bullet 67 \bullet dc)$

Output current rating can be increased (to 1 A maximum) by heat sinking or reducing the input voltage. With an infinite heat sink, $R_{-JA} = R_{-JT} = 6^{\circ}C/W$. Conditions that produce excessive junction temperature will activate device thermal shutdown circuitry. These conditions can be tolerated but should be avoided.



ELECTRICAL CHARACTERISTICS at T_A +25°C (unless otherwise noted).

			Limits			
Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Output Voltage	Vo	$\begin{split} T_A &= 25^\circ C, \ 5.5 \ V \leq V_I \leq 10 \ V, \\ 0 \ mA \leq I_O \leq 500 \ mA^+ \end{split}$	4.90	5.00	5.10	V
		$ \begin{array}{l} T_A = 85^{\circ}C, \ 5.5 \ V \leq V_I \leq 10 \ V, \\ 0 \ mA \leq I_O \leq 500 \ mA^* \\ \end{array} $	4.85	—	5.15	V
Output Volt. Temp. Coeff.	ανο	I _O = 0	_	±100	—	μV/°C
Line Regulation	$\Delta V_{O(\Delta VI)}$	5.5 V \leq V _I \leq 10 V, Output open	_	10	30	mV
Load Regulation	$\Delta V_{O(\Delta IO)}$	0 mA \leq I _O \leq 500 mA†, V _I = 6 V	_	40	100	mV
Dropout Voltage	V _I min - V _O	I _O = 500 mA†	—	_	300	mV
Quiescent Current (GND terminal current)	Ι _Q	$V_{I} = 10 \text{ V}, I_{O} = 500 \text{ mA}^{+}$	_	87	120	μA
		V _I = 10 V, Output open	—	86	120	μA
	I _{Q(off)}	V_{I} = 10 V, Output open, V_{E} = 0.4 V	—	—	20	μA
ENABLE Input Voltage	V _{EH}	Output ON, V _I = 10 V	2.4	_	_	V
	V _{EL}	Output OFF, V _I = 10 V	—	—	0.4	V
ENABLE Input Current	Ι _Ε	$V_{E} = V_{I} = 10 V$	—	_	±0.1	μA
Thermal Shutdown Temp.	TJ		_	165	_	°C
Thermal Resistance	R _{θJA}	Mounted on 2.24" x 2.24" solder-coated copper-clad board in still air	_	67		°C/W
	R _{θJT}		_	6.0	_	°C/W

Typical values are given for circuit design information only.

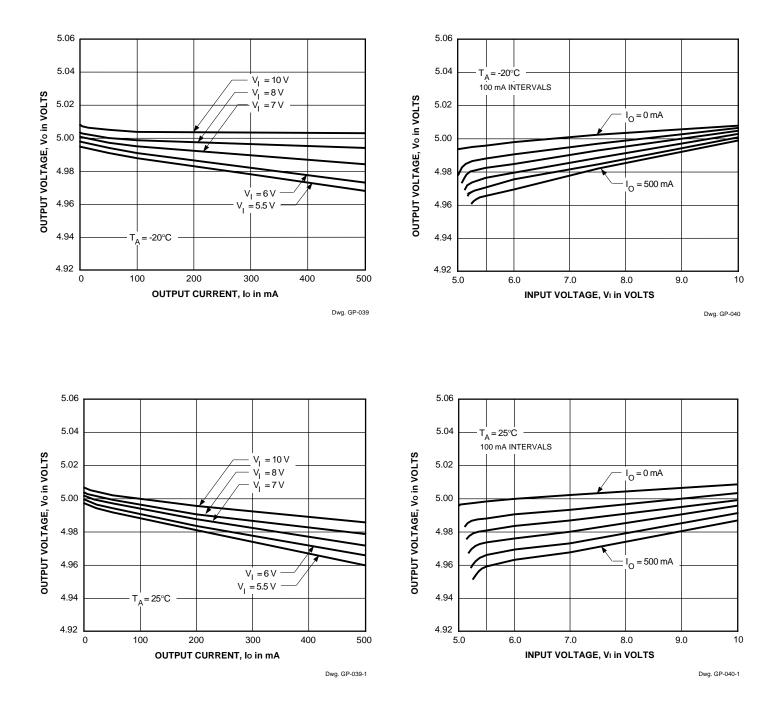
* This parameter is tested to a lot sample plan only.

† Pulse test (<20 ms).

TYPICAL CHARACTERISTICS

LOAD REGULATION

LINE REGULATION



CAUTION: Maximum allowable duty cycle will be significantly less than 100% at high temperatures, at high input voltages, or at high output currents. See Maximum Allowable Output Current table.



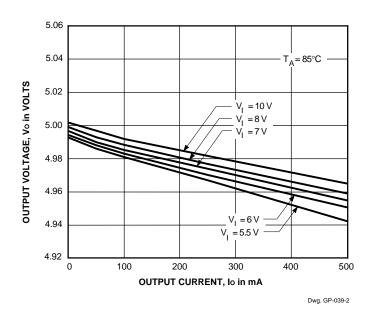
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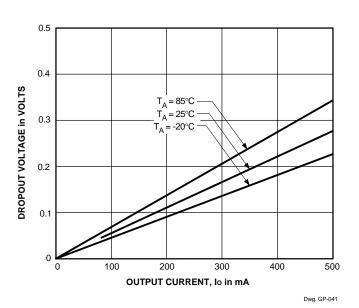
TYPICAL CHARACTERISTICS (cont'd)

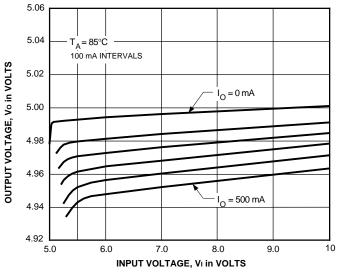
LOAD REGULATION

LINE REGULATION



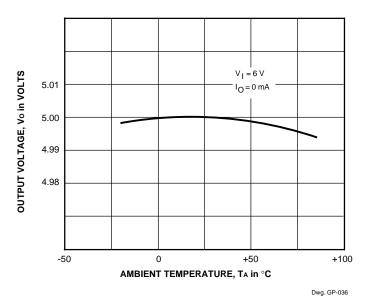
DROPOUT VOLTAGE





Dwg. GP-040-2

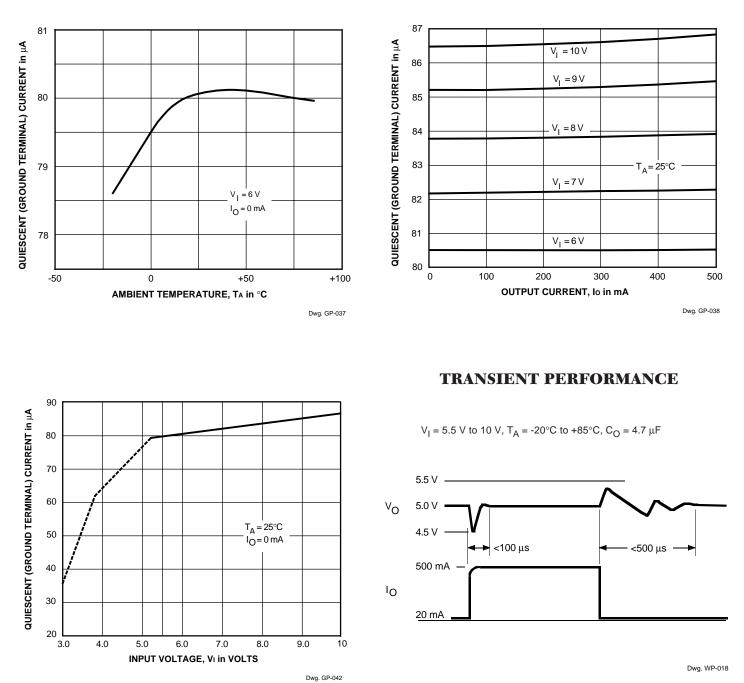
OUTPUT VOLTAGE vs TEMP.

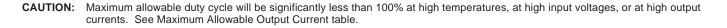


CAUTION: Maximum allowable duty cycle will be significantly less than 100% at high temperatures, at high input voltages, or at high output currents. See Maximum Allowable Output Current table.

TYPICAL CHARACTERISTICS (cont'd)

QUIESCENT (GROUND TERMINAL) CURRENT





Allogro.

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(Based on 1 mm = 0.3937") 16 9 0.0125 0.0091 R \square P П A 0.419 0.394 0.2992 0.2914 0.050 0.016 3 Ĥ Н Ш П 0.020 ł 2 0.050 0° то 8° 0.4133 0.3977 BSC 4 0.0926 0.1043 0.0040 MIN. Dwg. MA-008-17A in **Dimensions in Millimeters** 16 9 0.32 0.23 P _ P P Р _ • 10.65 10.00 7.60 7.40 1.27 0.40 Н H 0.51 0.33 . 2 3 1.27 BSC 0° то 8° 10.50 10.10 . 2.65 2.35 ¥ Ĺ

Dimensions in Inches

Dwg. MA-008-17A mm

NOTES: 1. Webbed lead frames. Leads 4, 5, 12, and 13 are internally one piece.

2. Lead spring tolerance is non-cumulative.

3. Exact body and lead configuration at vendor's option within limits shown.

0.10 MIN.



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